FUJITSU

FUJITSU Component Wireless Modules Bluetooth® Version 5.3 without Firmware

FWM7BLZ23-109172

Overview

Compact Bluetooth Version 5.3 (low energy single mode) module with antenna, without Fujitsu Component firmware. It is possible to communicate in 2.4 GHz Industrial Scientific Medical (ISM) band.

Features

- Replaceable with FWM7BLZ20/20B
 Same size and footprint as FWM7BLZ20/20B. It is possible to use an appropriate module according to required performance
- Increased memory
 256KB RAM and 1MB Flash memory
 QSPI for the high-speed external memory interface
- Long Range communcation
 Coded PHY (Long Range) enables approx. 4 times (theoretical value) long-distance communication compared to conventional products.

High output

High power output (+8 dBm) also contributes long range communication.

 30 GPIO pins of nRF52840-QFAA are assigned Possible to use pins as NFC*, SPI, TWI, URAT, ADC, QSPI Note*: external antenna is required to use NFC

Applications

IoT equipment, remote control and maintenance of equipment, etc.

😵 Bluetooth





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FWM7BLZ23-109172
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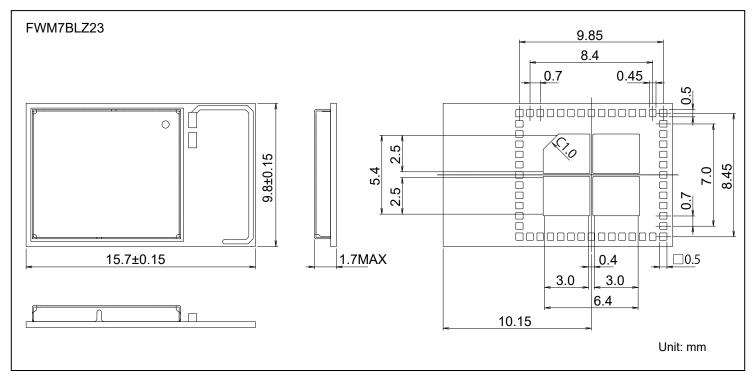
Specifications

Item	Specifications		
Part number	FWM7BLZ23 -109172		
Antenna	Embedded (Pattern antenna)		
Bluetooth technology	Conforms to Bluetooth Core Specification Version 5.3 technology (Low energy single mode)		
Carrier frequency	2,402 MHz to 2,480 MHz		
Modulation	GFSK		
RAM	256 KB		
FLASH	1,024 KB		
Output power	+8 dBm max.		
Receiver sensitivity	-94 dBm typical (1 Mbps BLE ideal transmitter packet length, ≥128 bytes BER=0.01%)		
Interface	NFC*1, SPI, TWI, UART, ADC, QSPI		
Crystal oscillator	Embedded		
Operating voltage	1.7 to 3.6 VDC		
Data rate	1 Mbps / 2 Mbps (ON-AIR)		
Number of channels	40 RF channels		
Advertising size	255 bytes (payload), max. 254 bytes (advertising data)		
SoC	nRF52840 (Nordic Semiconductor)		
Power consumption	Tx only	LDO mode: 10.6 mA typical (at 0 dBm), DC/DC mode: 4.8 mA typical (at 0 dBm)	
	Rx only	LDO mode: 9.9 mA typical (data rate 1 Mbps), 11.1 mA typical (data rate 2 Mbps) DC/DC mode: 4.6 mA typical (data rate 1 Mbps), 5.2 mA typical (data rate 2 Mbps)	
Operating temperature	-40°C to +85°C		
Dimensions	15.7 x 9.8 x 1.7 mm		
Mounting method	Surface mount (SMT)		
Certifications (plan)	Bluetooth gualification (QDID)*2, Radio Act (Japan), FCC, ISED, CE, UKCA		

Note:

*1: External antenna is required to use NFC *2: Bluetooth SIG registration is required to use modules QDID

Dimensions



Evaluation board

Part number	Details	
MBH-FUJI2-E1	Evaluation board (USB cable is attached)	
FWM7BLZ23-DAU-EB1	Daughter board (FWM7BLZ23 x 1 is mounted)	

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